Wuxi Unigroup Microelectronics Co.,Ltd.

60V N-Channel DTMOS

General Description

- **Trench Power SGT technology**
- Very low on-resistance $R_{DS(ON)}$
- Low Gate Charge
- Excellent Gate Charge x $R_{DS(ON)}$ Product

Applications

- High Frequency Switching and Synchronous Rectification

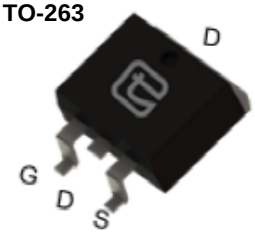
Product Summary

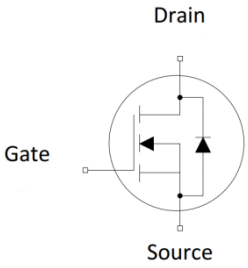
V_{DS}	60V
ID (at VGS=10V)	180A
RDS(ON) (at VGS=10V)	< 3mΩ

100% UIS Tested

RoHS

TO-263





Device	Package	Form	Marking
TSB15N06A	TO-263	Tape&Reel	B15N06A

Absolute Maximum Ratings (T_A =25ºC unless otherwise noted)

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_C = 25ºC	I_D	180	A
	T_C = 100ºC		108	
Pulsed Drain Current [A]		I_{DM}	720	A
Avalanche Current [A]		I_{AS}	28	A
Single Pulse Avalanche Energy L =0.3mH [A]		E_{AS}	609	mJ
Power Dissipation [C]	T_C =25ºC	P_D	208	W
	T_C =100ºC		125	W
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 175	ºC

Thermal Resistance

Parameter		Symbol	Maximum	Units
Maximum Junction-to-Case	Steady-State	R_{thJC}	0.6	ºC/W
Maximum Junction-to-Ambient	Steady-State	R_{thJA}	60	

Electrical Characteristics(T_J =25ºC unless otherwise noted)

Symbol	Parameter	Conditions		Value			Units
				Min	Typ	Max	
STATIC PARAMETERS							
BV_{DSS}	Drain-Source Breakdown Voltage	I_D =250μA,V_{GS} =0V		60	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} =60V, V_{GS} =0V	T_J =25ºC	--	--	1	μA
			T_J =100ºC	--	--	100	
I_{GSS}	Gate-Body Leakage Current	V_{DS} =0V, V_{GS} =±20V		--		±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} =V_{GS}, I_D =250μA		2	3	4	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =50A		--	2.5	3	mΩ
g_{FS}	Forward Transconductance	V_{DS} =10V, I_D =50A		--	140	--	S
V_{SD}	Diode Forward Voltage	I_S =50A, V_{GS} =0V		--	--	1	V
I_S	Maximum Body-Diode Continuous Current [B]			--	--	50	A
DYNAMIC PARAMETERS							
C_{iss}	Input Capacitance	V_{GS} =0V, V_{DS} =30V, f =1MH_Z		--	7700	--	pF
C_{oss}	Output Capacitance			--	667	--	
C_{rss}	Reverse Transfer Capacitance			--	66	--	
SWITCHING PARAMETERS							
Q_g(10V)	Total Gate Charge	V_{GS} =10V,V_{DS} =30V, I_D =50A		--	138	--	nC
Q_{gs}	Gate Source Charge			--	37	--	
Q_{gd}	Gate Drain Charge			--	35.5	--	
$t_{D(on)}$	Turn-On Delay Time	V_{GS} =10V,V_{DS} =30V, I_D =50A, R_G =3Ω		--	35	--	ns
t_r	Turn-On Rise Time			--	22	--	
$T_{D(off)}$	Turn-Off Delay Time			--	105	--	
t_f	Turn-Off Fall Time			--	45	--	
t_{rr}	Body Diode Reverse Recovery Time	I_F =50A, di/dt =500A/μs		--	50	--	ns
Q_{rr}	Body Diode Reverse Recovery Charge			--	110	--	nC

A. Single pulse width limited by maximum junction temperature.

B. The maximum current rating is package limited.

C. The power dissipation P_D is based on $T_{J(MAX)}$ =175ºC, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

Typical Characteristics T_J = 25ºC, unless otherwise noted

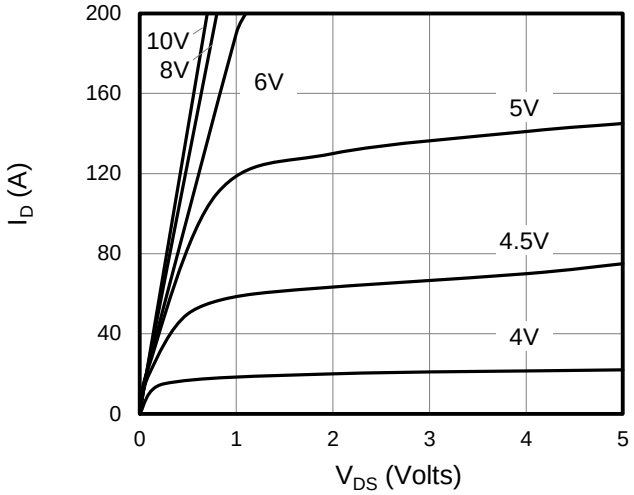


Figure 1: On-Region Characteristics

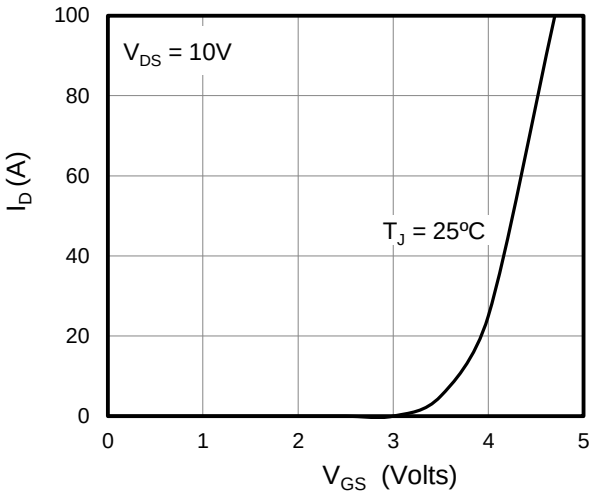


Figure 2: Transfer Characteristics

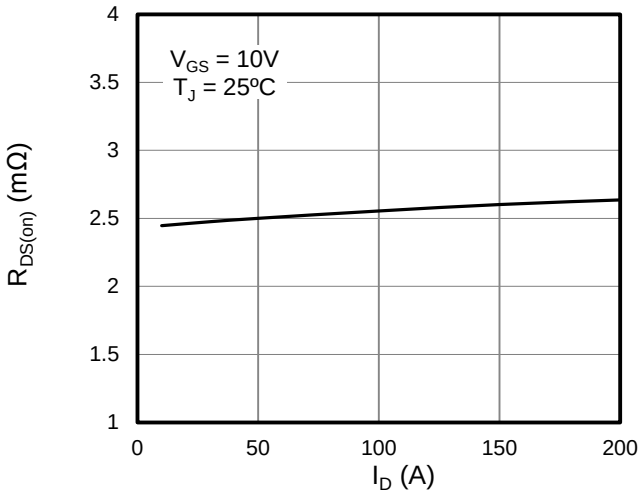


Figure 3: On-Resistance vs. Drain Current

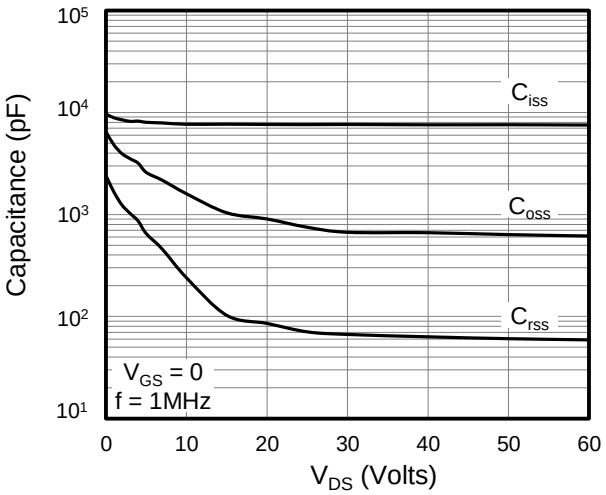


Figure 4: Capacitance Characteristics

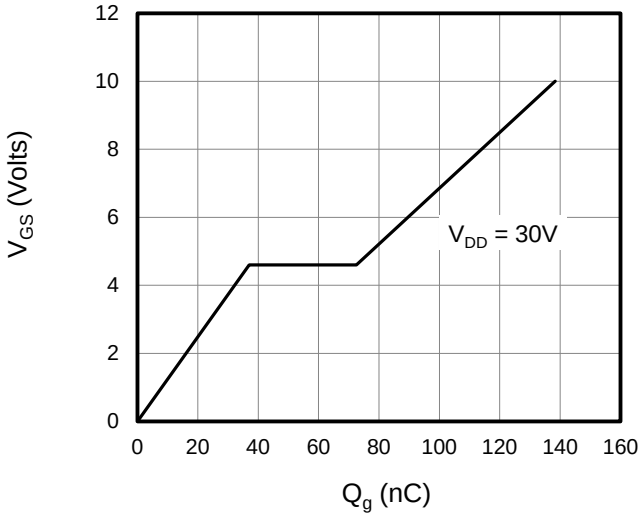


Figure 5: Gate Charge Characteristics

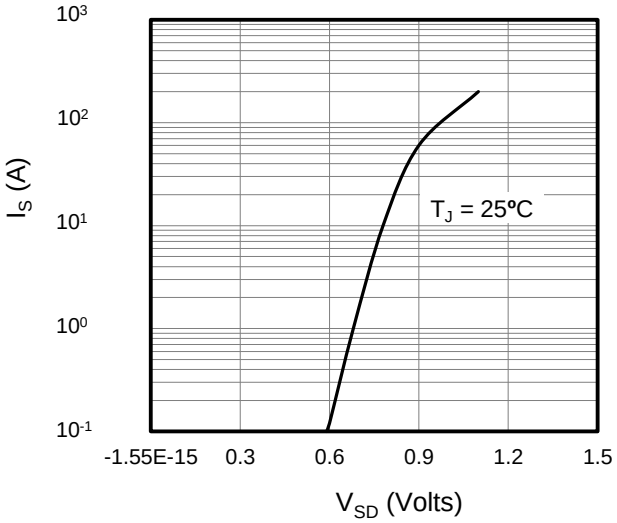


Figure 6: Body Diode Forward Voltage

Typical Characteristics T_J = 25ºC, unless otherwise noted

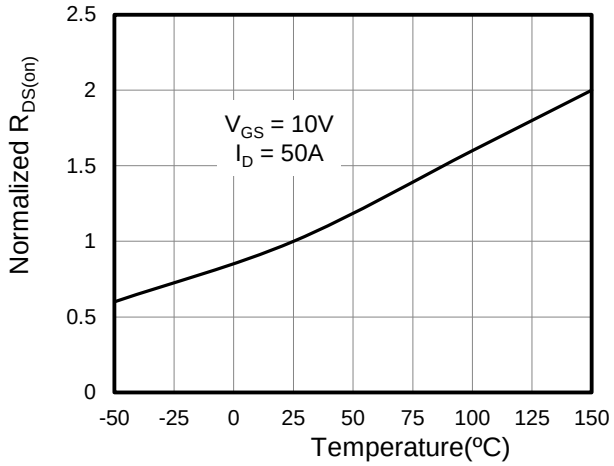


Figure 7: On-Resistance vs. Junction Temperature

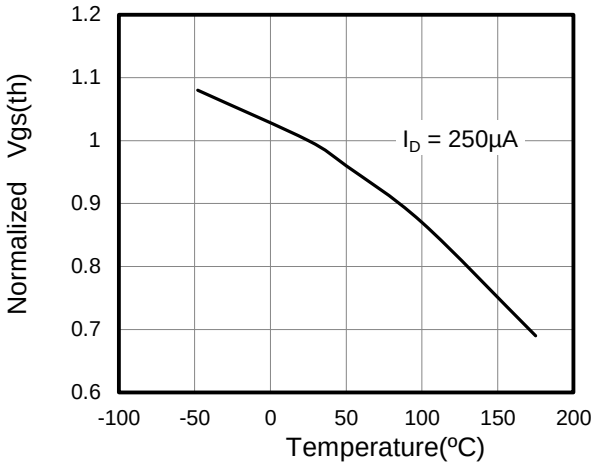


Figure 8: Vgs(th) vs. Junction Temperature

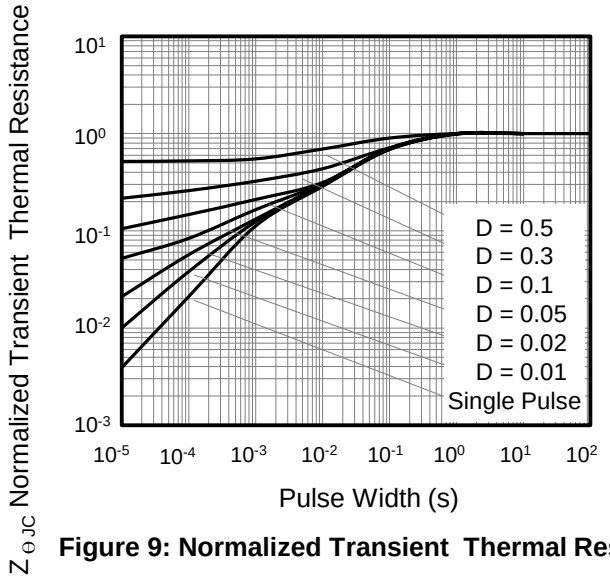


Figure 9: Normalized Transient Thermal Resistance

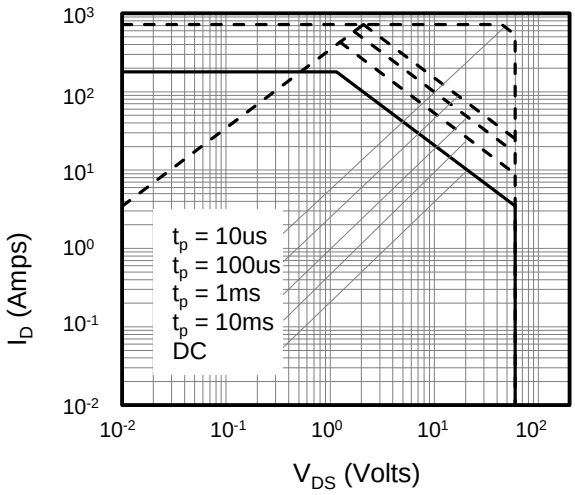


Figure 10: Safe Operating Area

Figure A：Gate Charge Test Circuit and Waveform

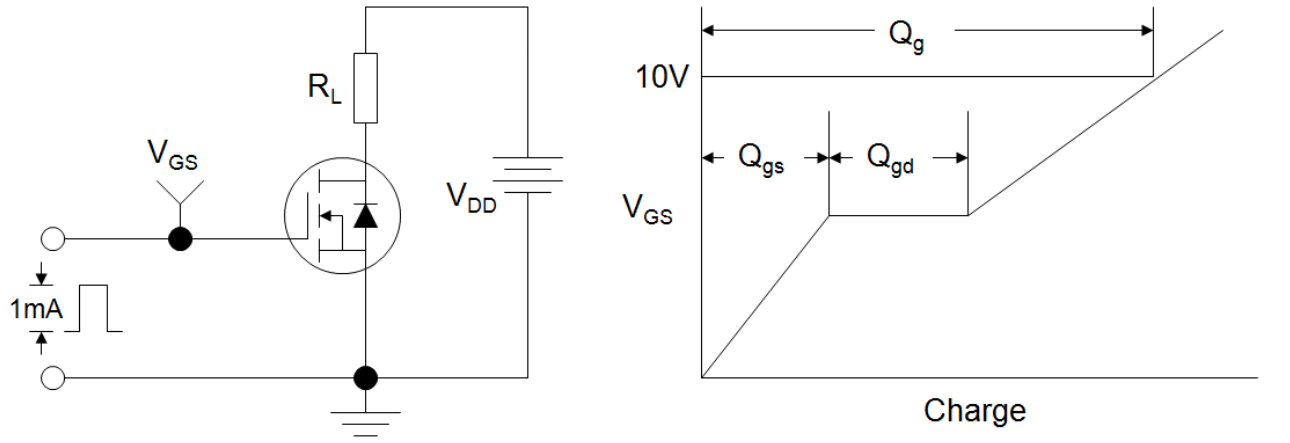


Figure B：Resistive Switching Test Circuit and Waveform

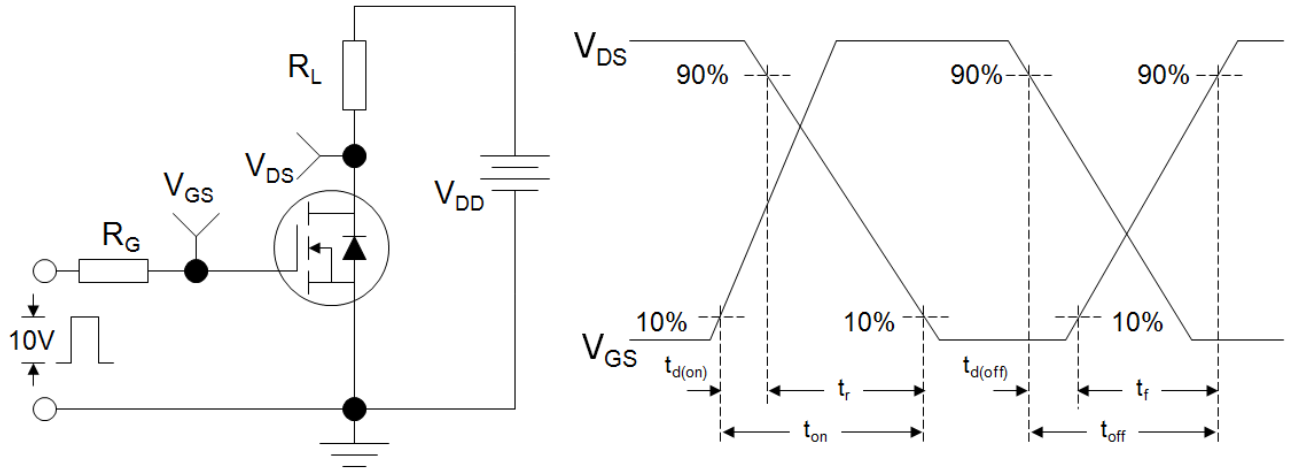
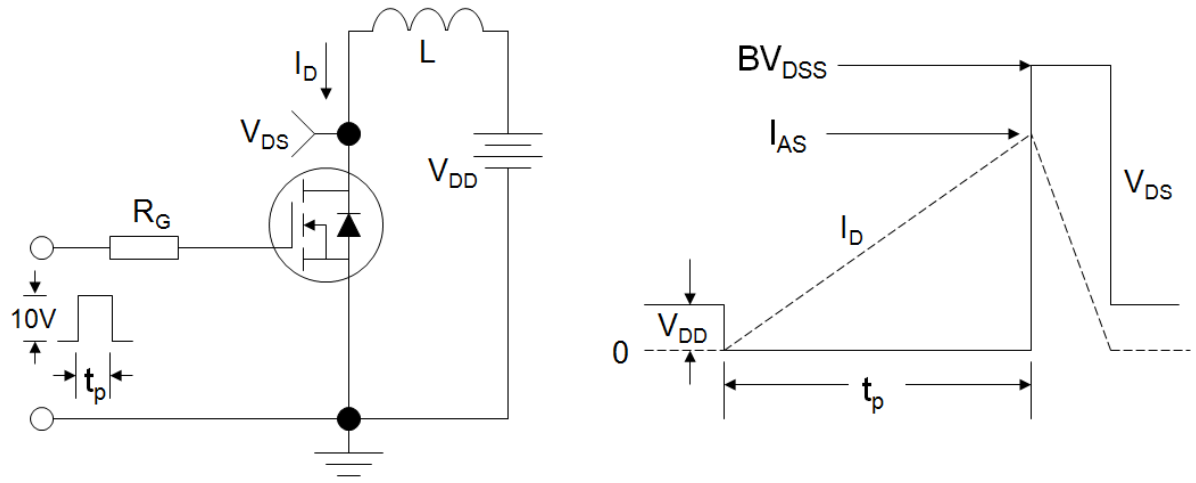


Figure C：Unclamped Inductive Switching Test Circuit and Waveform



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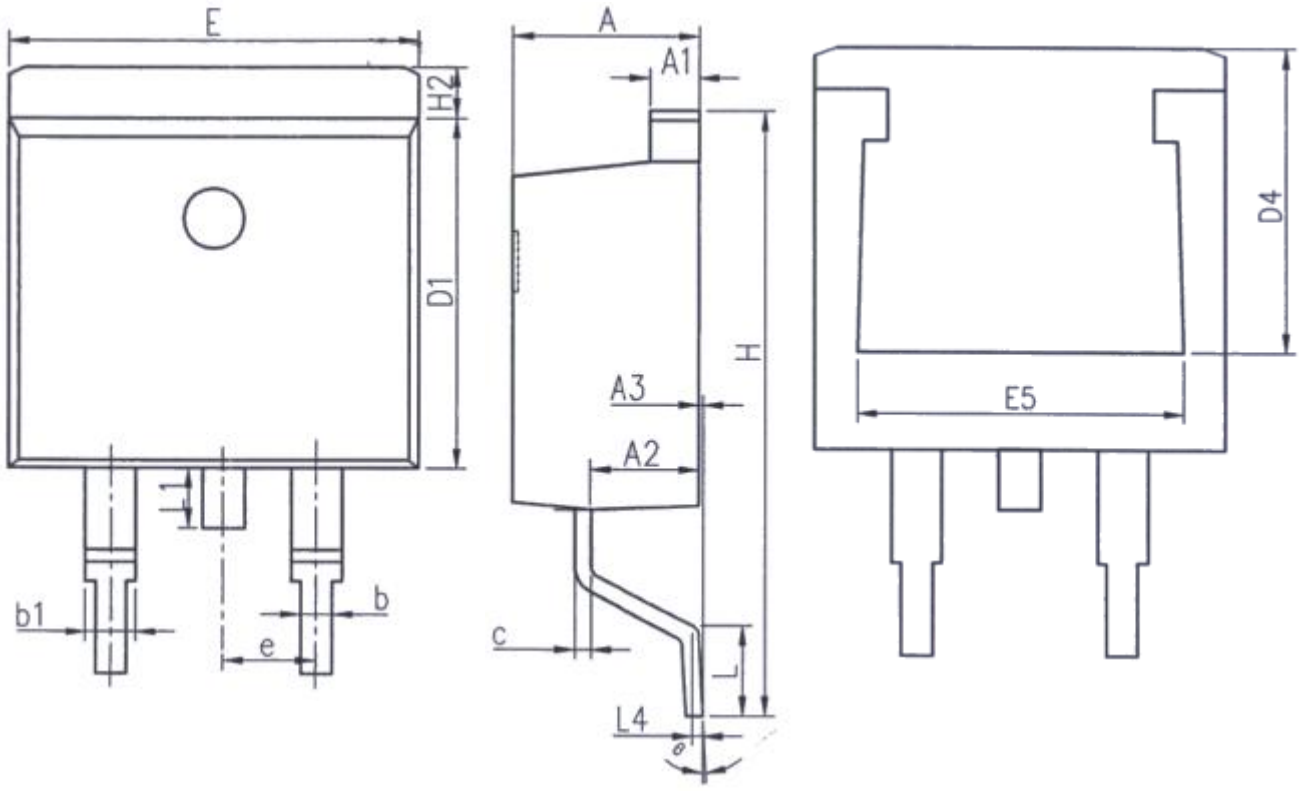

Unit: mm		
Symbol	Min.	Max.
A	4.37	4.77
A1	1.22	1.42
A2	2.49	2.89
A3	0.00	0.25
b	0.70	0.96
b1	1.17	1.47
c	0.30	0.53
D1	8.50	8.90
D4	6.60	-

Unit: mm		
Symbol	Min.	Max.
E	9.86	10.36
E5	7.06	-
e	2.54BSC	
H	14.70	15.50
H2	1.07	1.47
L	2.00	2.60
L1	1.40	1.70
L4	0.25BSC	
θ	0°	9°

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